





P-CHANNEL ENHANCEMENT MODE FIELD EFFECT TRANSISTOR

Features

- P-Channel MOSFET
- Very Low On-Resistance
- Very Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

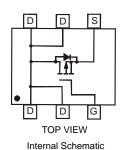
Mechanical Data

- Case: SOT-563
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Copper lead frame. Solderable per MIL-STD-202, Method 208
- Weight: 0.006 grams (approximate)

SOT-563



TOP VIEW



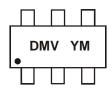
Ordering Information (Note 3)

Part Number	Case	Packaging		
DMP2104V-7	SOT-563	3000/Tape & Reel		

Notes:

- 1. No purposefully added lead.
 - 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.
 - 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



DMV = Marking Code YM = Date Code Marking Y = Year (ex: T = 2006)M = Month (ex: 9 = September)

Date Code Key

Year	200	6	2007		2008	20	09	2010		2011	2	2012
Code	Т		U		V	V	٧	Χ		Υ		Z
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings @T_A = 25°C unless otherwise specified

Characte	eristic	Symbol	Value	Units	
Drain-Source Voltage		V_{DSS}	-20	V	
Gate-Source Voltage		V_{GSS}	±12	V	
Continuous Drain Current (Note 4)	Steady State	$T_A = 25$ °C $T_A = 70$ °C	I _D	-860 -690	mA
Continuous Drain Current (Note 4)	t≤5s	$T_A = 25$ °C $T_A = 70$ °C	I _D	-950 -760	mA

Thermal Characteristics

Character	stic	Symbol	Value	Units
Power Dissipation (Note 4)	Steady State	P _D	170	mW
Power Dissipation (Note 4)	t ≤ 5s	P_{D}	210	mW
Pulsed Drain Current	t _p = 10μs	I _{DM}	-4.0	Α
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	°C	

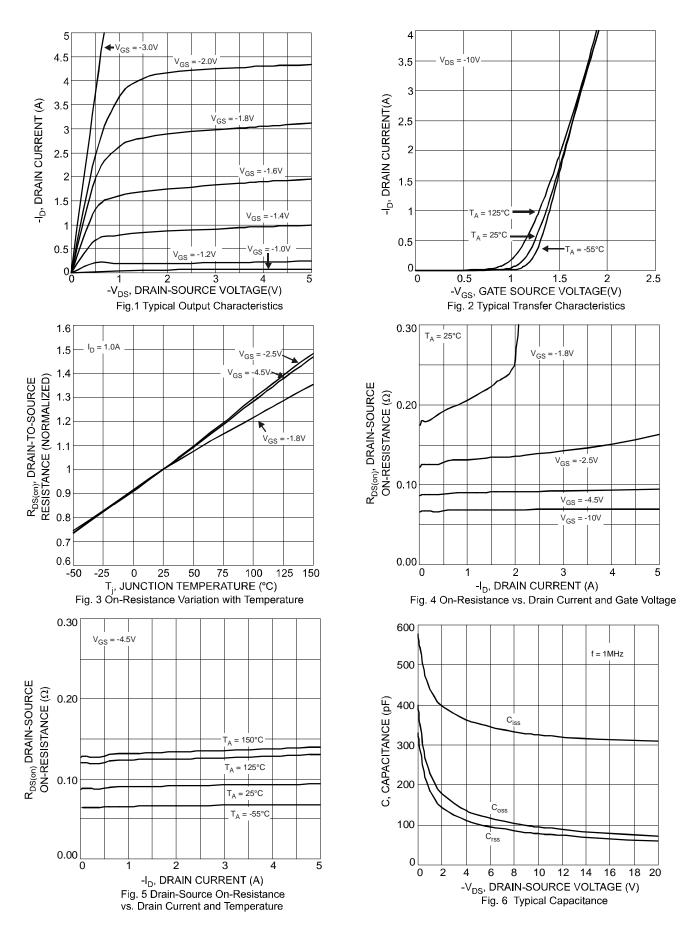
Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 5)								
Drain-Source Breakdown Voltage		BV _{DSS}	-20		_	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current	$T_J = 25$ °C $T_J = 125$ °C	I _{DSS}			-1.0 -5.0	μΑ	V _{DS} = -20V, V _{GS} = 0V	
Gate-Source Leakage		I _{GSS}		_	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 5)								
Gate Threshold Voltage		V _{GS(th)}	-0.45		-1.0	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$	
Static Drain-Source On-Resistance		R _{DS} (ON)		92 134 180	150 200 240	mΩ	$V_{GS} = -4.5V, I_D = -950mA$ $V_{GS} = -2.5V, I_D = -670mA$ $V_{GS} = -1.8V, I_D = -200mA$	
Forward Transconductance		g _{FS}		3.1	_	S	$V_{DS} = -10V, I_{D} = -810mA$	
Diode Forward Voltage (Note 5)		V_{SD}	_	_	-0.9	V	$V_{GS} = 0V, I_{S} = -360 \text{mA}$	
DYNAMIC CHARACTERISTICS								
Input Capacitance		Ciss		320	_	pF	101/11/	
Output Capacitance		Coss	_	80	_	pF	$V_{DS} = -16V, V_{GS} = 0V$ f = 1.0MHz	
Reverse Transfer Capacitance		C_{rss}		60	_	pF	71 = 1.0IVII 12	

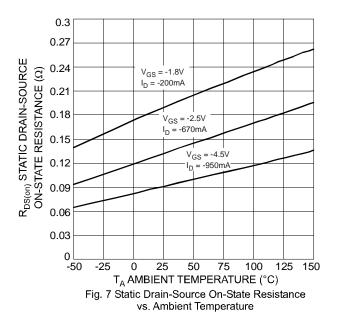
Notes:

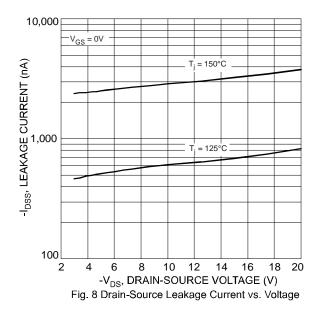
- 4. Device mounted on FR-4 PCB with 1 inch square pads.5. Short duration pulse test used to minimize self-heating effect.

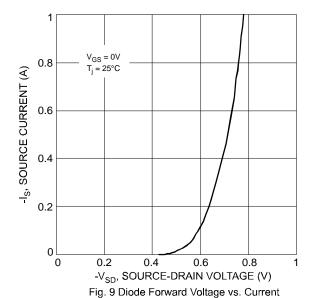


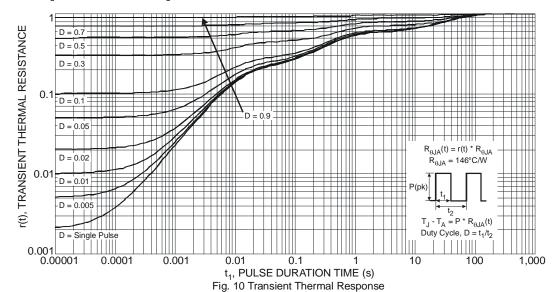






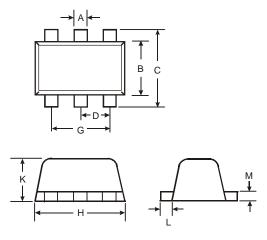






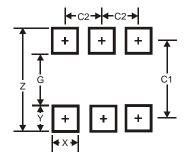


Package Outline Dimensions



SOT-563							
Dim	Min	Max	Тур				
Α	0.15	0.30	0.20				
В	1.10	1.25	1.20				
С	1.55	1.70	1.60				
D	-	-	0.50				
G	0.90	0.90 1.10					
Н	1.50	1.70	1.60				
K	0.55	0.60	0.60				
L	0.10	0.30	0.20				
M	0.10	0.18	0.11				
All	All Dimensions in mm						

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.2
G	1.2
Х	0.375
Υ	0.5
C1	1.7
C2	0.5



IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
 - 1. are intended to implant into the body, or
 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2011, Diodes Incorporated

www.diodes.com